

4-Mbit (512K X 8) Static RAM

Features

- Temperature ranges
 - □ Commercial: 0°C to 70°C
 - ☐ Industrial/Automotive -A: —40°C to 85°C
 - □ Automotive-E: -40°C to 125°C
- High Speed

 □ t_{AA} = 10 ns
- Low Active Power □ 324 mW (max)
- 2.0V Data Retention
- Automatic Power Down when Deselected
- TTL-compatible Inputs and Outputs
- Easy Memory Expansion with CE and OE features

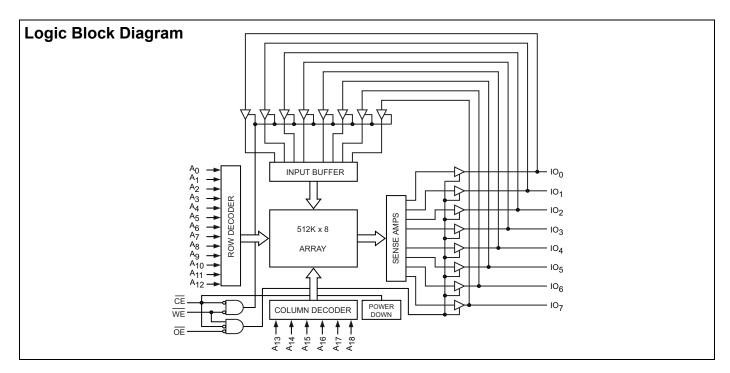
Functional Description

The CY7C1049CV33 is a high performance CMOS Static RAM organized as 524,288 words by eight bits. Easy memory expansion is provided by an active LOW Chip Enable ($\overline{\text{CE}}$), an active LOW Output Enable ($\overline{\text{OE}}$), and three-state drivers. Writing to the device is accomplished by taking Chip Enable ($\overline{\text{CE}}$) and Write Enable ($\overline{\text{WE}}$) inputs LOW. Data on the eight I/O pins (I/O0 through I/O7) is then written into the location specified on the address pins (A_0 through A_{18}).

The eight input and output pins (I/O $_0$ through I/O $_7$) are place<u>d in</u> a high impedance state when the device is deselected (\overline{CE} HIGH), the outputs are disabled (\overline{OE} HIGH), or during a write operation (\overline{CE} LOW, and \overline{WE} LOW).

The CY7C1049CV33 is available in standard 400-mil-wide 36-pin SOJ package and 44-pin TSOP II package with center power and ground (revolutionary) pinout.

For best practice recommendations, refer to the Cypress application note AN1064, SRAM System Guidelines.



CY7C1049CV33



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Pin Configuration

Figure 1. 36-Pin SOJ (Top View)

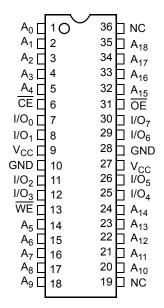
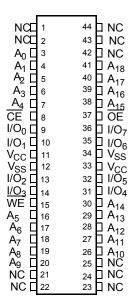


Figure 2. 44-Pin TSOP II (Top View)



Selection Guide

	Description					Unit
Maximum Access Time			10	12	15	ns
Maximum Operating Current	Commercial		90	85	-	mA
	Industrial/Automotive-A		100	95	-	mA
	Automotive-E		-	-	95	mA
Maximum CMOS Standby Current	Commercial/Industrial/ Automotive-A		10	10	-	mA
	Automotive-E		-	-	15	mA



Pin Definitions

Pin Name	36-SOJ Pin Number	44 TSOP-II Pin Number	I/O Type	Description
A ₀ -A ₁₈	1–5,14–18, 20–24,32–35	3–7,16–20, 26–30,38–41	Input	Address inputs used to select one of the address locations.
I/O ₀ –I/O ₇	7,8,11,12,25, 26,29,30	9,10,13,14, 31,32,35,36	Input/Output	Bidirectional data I/O lines. Used as input or output lines depending on operation
NC ^[1]	19,36	1,2,21,22,23,2 4,25,42,43, 44	No Connect	No connects. This pin is not connected to the die
WE	13	15	Input/Control	Write Enable input, active LOW. When selected LOW, a WRITE is conducted. When selected HIGH, a READ is conducted.
CE	6	8	Input/Control	Chip Enable input, active LOW. When LOW, selects the chip. When HIGH, deselects the chip.
ŌĒ	31	37	Input/Control	Output Enable, active LOW. Controls the direction of the I/O pins. When LOW, the I/O pins are allowed to behave as outputs. When deasserted HIGH, I/O pins are three-stated, and act as input data pins.
V _{SS} , GND	10,28	12,34	Ground	Ground for the device. Should be connected to ground of the system.
V _{CC}	9,27	11,33	Power Supply	Power supply inputs to the device.

Note
1. NC pins are not connected on the die.



Maximum Ratings

Exceeding maximum ratings may impair the useful life of the device. These user guidelines are not tested.

Ambient Temperature with

Supply Voltage on $\rm V_{CC}$ to Relative $\rm GND^{[2]}\mbox{--}0.5V$ to +4.6VDC

Voltage Applied to Outputs in High-Z State $^{[2]}$ –0.5V to $\rm V_{CC}$ + 0.5V

Input Voltage^[2]-0.5V to V_{CC} + 0.5V

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	$3.3\text{V} \pm 0.3\text{V}$
Industrial/ Automotive-A	–40°C to +85°C	
Automotive-E	-40°C to +125°C	

Electrical Characteristics

Over the Operating Range

Parameter	Description	Test Condition	ne		10	-	12	-	15	Unit
raiailletei	Description	lest condition	rest conditions			Min	Max	Min	Max	Oilit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.; I_{OH} = -4.0 \text{ m/s}$	4	2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min.,; I _{OL} = 8.0 mA			0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	V
V _{IL}	Input LOW Voltage ^[2]			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \leq V_I \leq V_CC$	Com'l/Ind'l/ Auto-A	-1	+1	– 1	+1			μА
			Auto-E					-20	+20	
I _{CC}	V _{CC} Operating	V _{CC} = Max.,	Com'l		90		85			mA
	Supply Current	$f = f_{MAX} = 1/t_{RC}$	Ind'I/Auto-A		100		95			
			Auto-E						95	
I _{SB1}	Automatic CE Power Down Current	Max. V_{CC} , $\overline{CE} \ge V_{IH}$; $V_{IN} \ge V_{IH}$ or	Com'l/Ind'l/ Auto-A		40		40			mA
	—TTL Inputs	$V_{IN} \leq V_{IL}$, $f = f_{MAX}$	Auto-E						45	mA
I _{SB2}	Automatic CE Power Down Current	$\frac{\text{Max. V}_{\text{CC}},}{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3\text{V},$	Com'l/Ind'l/ Auto-A		10		10			mA
	—CMOS Inputs	$V_{IN} \ge V_{CC} - 0.3V$, or $V_{IN} \le 0.3V$, f = 0	Auto-E						15	mA

Capacitance

Tested initially and after any design or process changes that may affect these parameters.

Parameter	Description	Test Conditions	Max	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	8	pF
C _{OUT}	I/O Capacitance	V _{CC} = 3.3V	8	pF

Thermal Resistance

Tested initially and after any design or process changes that may affect these parameters.

Pa	arameter	Description	Test Conditions	36-Pin SOJ	44-TSOP-II	Unit
	0/ (to Ambient)	Test conditions follow standard test methods and procedures for	46.51	41.66	°C/W
	- 30	LITIETHIAI DESISIANCE	measuring thermal impedance, per EIA / JESD51.	18.8	10.56	°C/W

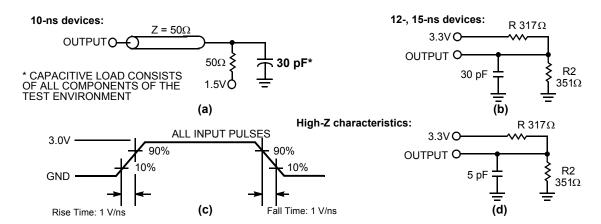
Notes

- V_{IL} (min) = -2.0V and V_{IH}(max) = V_{CC} + 0.5V for pulse durations of less than 20 ns.
 Tested initially and after any design or process changes that may affect these parameters.

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Figure 3. AC Test Loads and Waveforms [3]



Note

AC characteristics (except High-Z) for 10 ns parts are tested using the load conditions shown in Figure (a). All other speeds are tested using the Thevenin load shown in Figure (b). High-Z characteristics are tested for all speeds using the test load shown in Figure (d).



AC Switching Characteristics

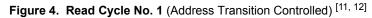
Over the Operating Range [5]

		-1	0	-12		-15		
Parameter	Description	Min	Max	Min	Max	Min	Max	Unit
Read Cycle		<u>'</u>				•		•
t _{power} ^[6]	V _{CC} (typical) to the first access	100		100		100		μS
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3			3	ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		5		6		7	ns
t _{LZOE}	OE LOW to Low-Z	0		0		0		ns
t _{HZOE}	OE HIGH to High-Z ^[7, 8]		5		6		7	ns
t _{LZCE}	CE LOW to Low-Z ^[8]	3		3		3		ns
t _{HZCE}	CE HIGH to High-Z ^[7, 8]		5		6		7	ns
t _{PU}	CE LOW to Power Up	0		0		0		ns
t _{PD}	CE HIGH to Power Down		10		12		15	ns
Write Cycle [9, 10]							
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	7		8		10		ns
t _{AW}	Address Setup to Write End	7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Setup to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		8		10		ns
t _{SD}	Data Setup to Write End	5		6		7		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low-Z ^[8]	3		3		3		ns
t _{HZWE}	WE LOW to High-Z ^[7, 8]		5		6		7	ns

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V.
 t_{POWER} gives the minimum amount of time that the power supply should be at stable, typical V_{CC} values until the first memory access can be performed.
 t_{HZOE}, t_{HZOE}, and t_{HZWE} are specified with a load capacitance of 5 pF as in part (d) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
 At any given temperature and voltage condition, t_{HZCE} is less than t_{LZOE}, t_{HZOE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.
 The internal Write time of the memory is defined by the overlap of CE LOW, and WE LOW. CE and WE must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data setup and hold timing should be referenced to the leading edge of the signal that terminates the Write.
 The minimum Write cycle time for Write Cycle No. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}.



Switching Waveforms



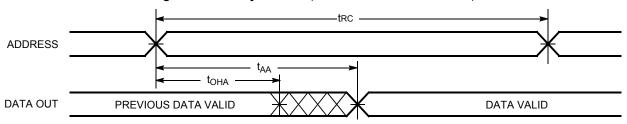


Figure 5. Read Cycle No. 2 (OE Controlled) [12, 13]

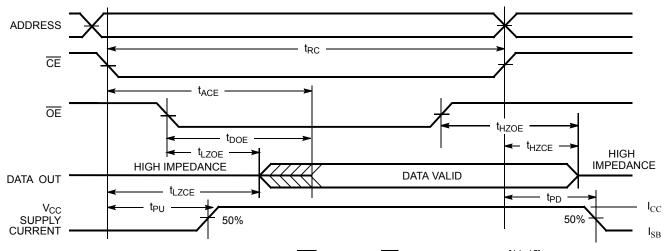
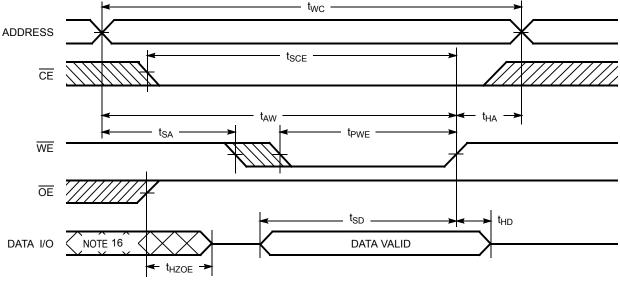


Figure 6. Write Cycle No. 1 (WE Controlled, OE HIGH During Write) [14, 15]



Notes

- 11. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{|L}$.

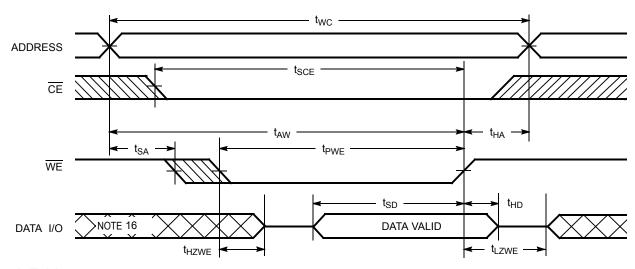
 12. \overline{WE} is HIGH for read cycles.
- 13. Address valid before or similar to $\overline{\text{CE}}$ transition LOW.
- 14. Data I/O is high impedance if \overline{OE} = $V_{|\underline{H}...}$ 15. If \overline{CE} goes HIGH simultaneously with \overline{WE} HIGH, the output remains in high impedance state.
- 16. During this period, the I/Os are in output state. Do not apply input signals.

[+] Feedback



Switching Waveforms (continued)

Figure 7. Write Cycle No. 2 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW) [15]



Truth Table

CE	OE	WE	I/O ₀ –I/O ₇	Mode	Power
Н	Х	X	High-Z	Power Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High-Z	Selected, Outputs Disabled	Active (I _{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
10	CY7C1049CV33-10VXC	51-85090	36-Pin (400-Mil) Molded SOJ (Pb-Free)	Commercial
	CY7C1049CV33-10VXA	51-85090	36-Pin (400-Mil) Molded SOJ (Pb-Free)	Automotive-A
12	CY7C1049CV33-12ZSXA	51-85087	44-Pin TSOP II (Pb-Free)	Automotive-A
15	CY7C1049CV33-15VXE	51-85090	36-Pin (400-Mil) Molded SOJ (Pb-Free)	Automotive-E
	CY7C1049CV33-15ZSXE	51-85087	44-Pin TSOP II (Pb-Free)	



Package Diagrams

Figure 8. 36-Pin (400-Mil) Molded SOJ V36, 51-85090

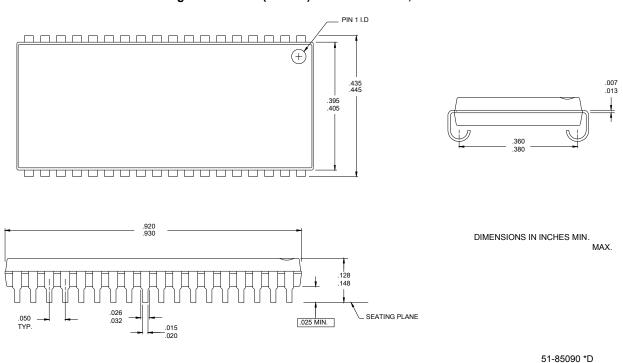
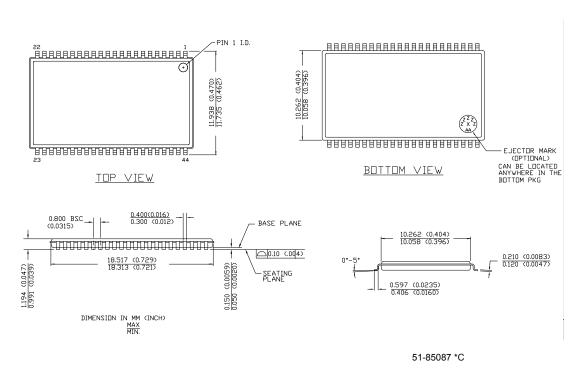


Figure 9. 44-Pin TSOP II, 51-85087

44 Lead TSOP TYPE II - STANDARD



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Document History Page

Rev.	ECN	Orig. of	Submission	Description of Change			
		Change	Date				
**	112569	HGK	03/06/02	New data sheet			
*A	114091	DFP	04/25/02	Changed Tpower unit from ns to μs			
*B	116479	CEA	09/16/02	Add applications foot note to data sheet, page 1.			
*C	262949	RKF	See ECN	Added Automotive-E Specs Added $\Theta_{\rm JA}$ and $\Theta_{\rm JC}$ values on Page #3.			
*D	300091	RKF	See ECN	Added -20-ns Speed bin			
*E	344595	SYT	See ECN	Added Pb-Free package on page #8 Removed shading for CY7C1049CV33-15ZSXE in the ordering Information on page 9			
*F	2615344	VKN/PYRS	12/03/08	Added Automotive-A information Removed 8 ns and 20 ns speed bins, Changed t _{POWER} spec from 1 μs to 100 μs, Updated Ordering Information table.			
*G	2841563	NXR/	01/07/2010	Added CY7C1049CV33-10VXA to Ordering Info table.			
*H	2898958	AJU	03/25/10	Removed inactive parts from the ordering information table. Updated package diagrams.			

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